# 150 mA, Ultra Low Supply Current, Low Dropout Regulator

The NCP4682 and NCP4685 are CMOS Low Dropout Linear voltage regulators with 150 mA output current capability. The devices have high output voltage accuracy, a 1  $\mu A$  (typ.) ultra low supply current and high ripple rejection. Current fold–back protection is integrated in the devices to protect against over current and short current conditions. A Chip Enable (NCP4682 only) function is included to save power by further lowering supply current, which is advantageous for battery powered applications. The NCP4685 is optimized for the lowest quiescent current possible in applications where the device is always on.

#### **Features**

- Operating Input Voltage Range: 1.70 V to 5.25 V
- Output Voltage Range: 1.2 V to 3.3 V (available in 0.1 V steps)
- Output Voltage Accuracy: ±0.8%
- Excellent Output Voltage Temperature Coefficient : ±40 ppm/°C
- Supply Current: 1.0 μA (excluding CE pull down current)
- Standby Current: 0.1 μA
- Dropout Voltage:  $0.24 \text{ V} (I_{OUT} = 150 \text{ mA}, V_{OUT} = 2.8 \text{ V})$
- Line Regulation: 0.02%/V Typ.
- Stable with Ceramic Capacitors: 0.1 μF or more
- Current Fold Back Protection
- Available in UDFN4 1.0 x 1.0 mm, SC-82AB, SOT23 Packages
- These are Pb-Free Devices

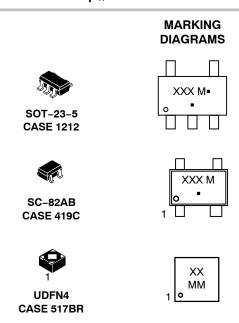
#### **Typical Applications**

- Battery-Powered Equipment
- Networking and Communication Equipment
- Cameras, DVRs, STB and Camcorders
- Home Appliances



# ON Semiconductor™

http://onsemi.com



XXX, XX = Specific Device Code

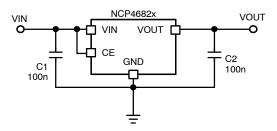
M, MM = Date Code

■ = Pb-Free Package

(\*Note: Microdot may be in either location)

# **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 19 of this data sheet.



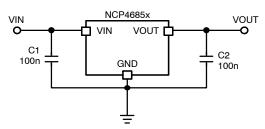
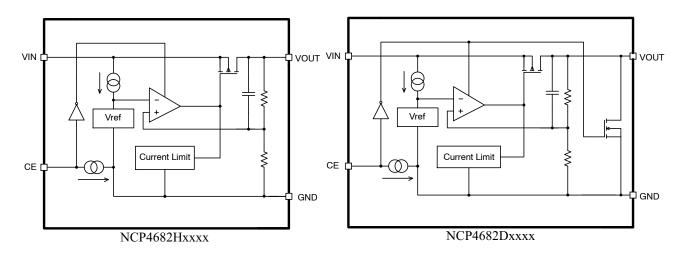


Figure 1. Typical Application Schematics



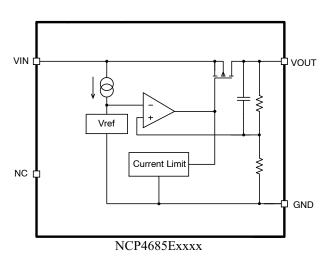


Figure 2. Simplified Schematic Block Diagram

# PIN FUNCTION DESCRIPTION

Pin No. UDFN1010*	Pin No. SC-82AB	Pin No. SOT23	Pin Name	Description
1	3	5	V <sub>OUT</sub>	Output pin
2	2	2	GND	Ground
3	1	3	CE/NC	Chip enable pin (Active "H") / No connection
4	4	1	V <sub>IN</sub>	Input pin
-	-	4	NC	No connection

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	$V_{IN}$	6.0	V
Output Voltage	V <sub>OUT</sub>	-0.3 to Vin + 0.3	V
Chip Enable Input	V <sub>CE</sub>	6.0	V
Output Current	I <sub>OUT</sub>	200	mA

<sup>\*</sup>Tab is GND level. (They are connected to the reverse side of this IC.)

The tab is better to be connected to the GND, but leaving it open is also acceptable.

#### **ABSOLUTE MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Power Dissipation UDFN1010		400	
Power Dissipation SC-82AB	P <sub>D</sub>	380	mW
Power Dissipation SOT23		420	
Junction Temperature	T <sub>J</sub>	-40 to 150	°C
Storage Temperature	T <sub>STG</sub>	-55 to 125	°C
ESD Capability, Human Body Model (Note 2)	ESD <sub>HBM</sub>	2000	V
ESD Capability, Machine Model (Note 2)	ESD <sub>MM</sub>	200	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Refer to ELÉCTRICAL CHARACTERISTIS and APPLICATION INFORMATION for Safe Operating Area.
- 2. This device series incorporates ESD protection and is tested by the following methods:
  - ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114)
  - ESD Machine Model tested per AEC-Q100-003 (EIA/JESD22-A115)
  - Latchup Current Maximum Rating tested per JEDEC standard: JESD78.

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Characteristics, UDFN 1.0 x 1.0 mm Thermal Resistance, Junction-to-Air	$R_{ heta JA}$	250	°C/W
Thermal Characteristics, SOT23 Thermal Resistance, Junction-to-Air	$R_{ heta JA}$	238	°C/W
Thermal Characteristics, SC-82AB Thermal Resistance, Junction-to-Air	$R_{ heta JA}$	263	°C/W

#### **ELECTRICAL CHARACTERISTICS**

 $-40^{\circ}C \le T_A \le 85^{\circ}C$ ;  $V_{IN} = V_{OUT(NOM)} + 1$  V or 2.5 V, whichever is greater;  $I_{OUT} = 1$  mA,  $C_{IN} = C_{OUT} = 0.1$   $\mu F$ , unless otherwise noted. Typical values are at  $T_A = +25^{\circ}C$ .

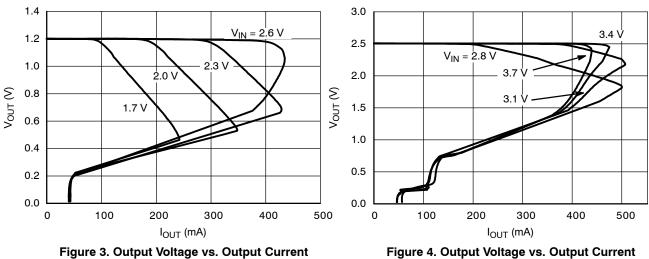
Parameter	Test Co	onditions	Symbol	Min	Тур	Max	Unit
Operating Input Voltage	(Note 3)		V <sub>IN</sub>	1.70		5.25	V
Output Voltage	$T_A = +25  ^{\circ}C$ $V_{OUT} \ge 2.0  V$		V <sub>OUT</sub>	x0.992		x1.008	V
		V <sub>OUT</sub> < 2.0 V		-16		16	mV
	$-40^{\circ}C \le T_A \le 85^{\circ}C$	V <sub>OUT</sub> ≥ 2.0 V		x0.985		x1.015	V
		V <sub>OUT</sub> < 2.0 V		-30		30	mV
Output Voltage Temp. Coefficient	-40°C ≤ T <sub>A</sub> ≤ 85°C		ΔV <sub>OUT</sub> / ΔΤ <sub>Α</sub>		±40		ppm/°C
Line Regulation	$V_{OUT(NOM)} + 0.5 \text{ V} \le V_{IN} \le 5.0 \text{ V}$		Line <sub>Reg</sub>		0.02	0.10	%/V
Load Regulation	IOUT = 1 mA to 150 mA		Load <sub>Reg</sub>		10	20	mV
Dropout Voltage	I <sub>OUT</sub> = 150 mA	1.2 V ≤ V <sub>OUT</sub> < 1.5 V	$V_{DO}$		0.76	1.05	V
		1.5 V ≤ V <sub>OUT</sub> < 1.7 V			0.53	0.80	
		1.7 V ≤ V <sub>OUT</sub> < 2.0 V			0.44	0.65	
		2.0 V ≤ V <sub>OUT</sub> < 2.5 V			0.34	0.50	
		2.5 V ≤ V <sub>OUT</sub> < 2.8 V			0.28	0.40	
		$2.8 \text{ V} \le \text{V}_{OUT} < 3.3 \text{ V}$			0.24	0.32	
Output Current		•	l <sub>out</sub>	150			mA
Short Current Limit	V <sub>OUT</sub> = 0 V		I <sub>SC</sub>		40		mA
Quiescent Current			lQ		1.0	1.5	μΑ

# **ELECTRICAL CHARACTERISTICS**

 $-40^{\circ}C \leq T_{A} \leq 85^{\circ}C; \ V_{IN} = V_{OUT(NOM)} + 1 \ V \ or \ 2.5 \ V, \ whichever is greater; \ I_{OUT} = 1 \ mA, \ C_{IN} = C_{OUT} = 0.1 \ \mu F, \ unless \ otherwise \ noted.$  Typical values are at  $T_{A} = +25^{\circ}C$ .

Parameter	rameter Test Conditions		Min	Тур	Max	Unit
Standby Current	V <sub>CE</sub> = 0 V, T <sub>A</sub> = 25°C, NCP4682 only	I <sub>STB</sub>		0.1	1.0	μΑ
CE Pin Threshold Voltage	CE Input Voltage "H"	V <sub>CEH</sub>	1.5			V
(NCP4682 only)	CE Input Voltage "L"	V <sub>CEL</sub>			0.3	
CE Pull Down Current	NCP4682 only	I <sub>CEPD</sub>		0.3		μΑ
Power Supply Rejection Ratio	$V_{IN} = 2.2 \text{ V}, V_{OUT} = 1.2 \text{ V}, \Delta V_{IN} = 0.2 \text{ V}_{pk-pk}, \\ I_{OUT} = 30 \text{ mA, f} = 1 \text{ kHz}$			30		dB
Output Noise Voltage	f = 10 Hz to 100 kHz, $I_{OUT}$ = 30 mA, $V_{OUT}$ = 1.2 V, $V_{IN}$ = 2.2 V	V <sub>N</sub>		70		$\mu V_{rms}$
Low Output Nch Tr. On Resistance	V <sub>IN</sub> = 4 V, V <sub>CE</sub> = 0 V, NCP4682D only	$R_{LOW}$		30		Ω

<sup>3.</sup> The maximum Input Voltage of the Electrical Characteristics is 5.25 V. In case of exceeding this specification, the IC must be operated n condition that the Input Voltage is up to 5.50 V and total operation time is within 500 hours.



1.2 V Version  $(T_J = 25^{\circ}C)$ 

2.5 V Version  $(T_J = 25^{\circ}C)$ 

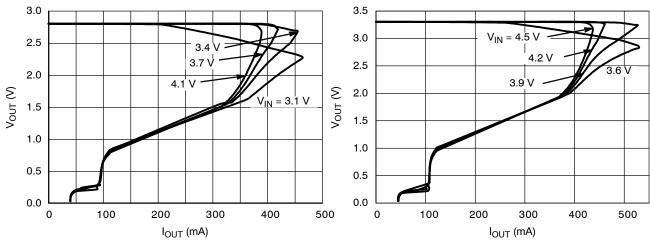
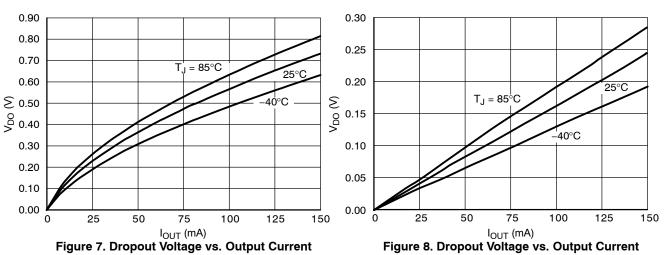


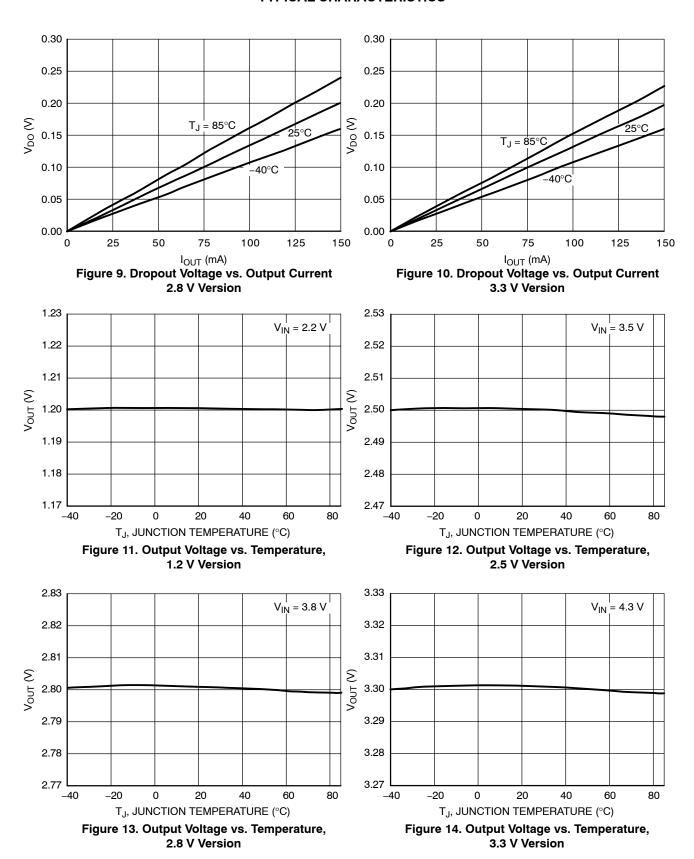
Figure 5. Output Voltage vs. Output Current 2.8 V Version (T<sub>J</sub> = 25°C)

Figure 6. Output Voltage vs. Output Current 3.3 V Version (T<sub>J</sub> = 25°C)



1.2 V Version

2.5 V Version



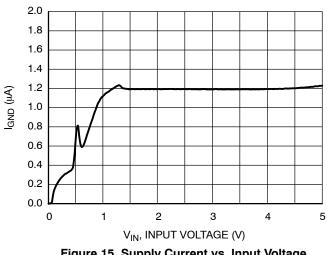


Figure 15. Supply Current vs. Input Voltage, 1.2 V Version

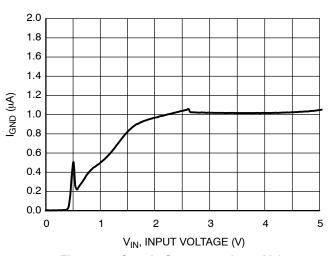


Figure 16. Supply Current vs. Input Voltage, 2.5 V Version

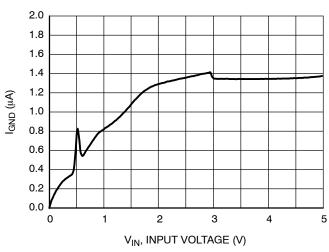


Figure 17. Supply Current vs. Input Voltage, 2.8 V Version

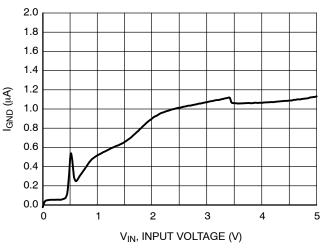


Figure 18. Supply Current vs. Input Voltage, 3.3 V Version

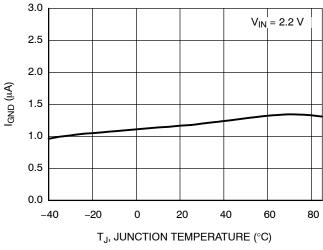


Figure 19. Supply Current vs. Temperature, 1.2 V Version

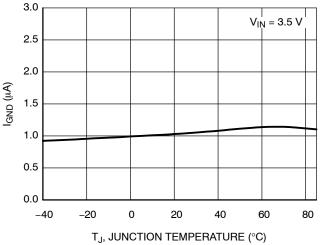
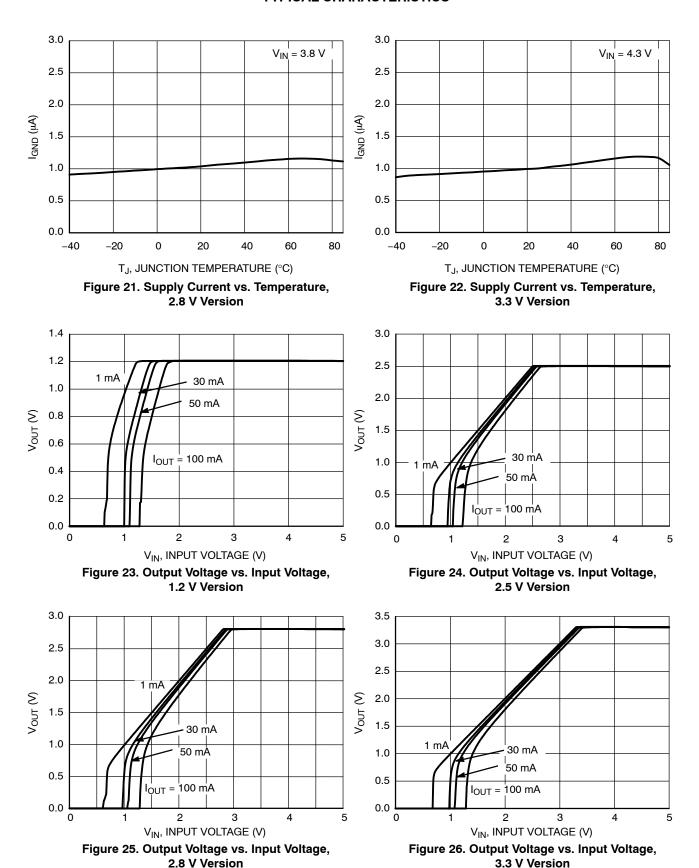


Figure 20. Supply Current vs. Temperature, 2.5 V Version



# **TYPICAL CHARACTERISTICS**

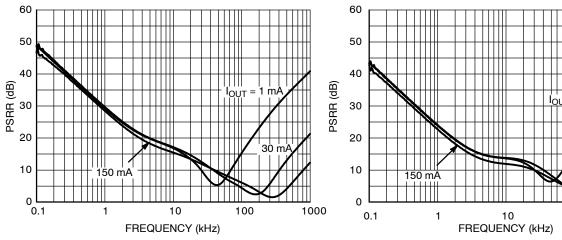


Figure 27. PSRR, 1.2 V Version,  $V_{IN}$  = 2.2 V

Figure 28. PSRR, 2.5 V Version,  $V_{IN}$  = 3.5 V

100

1000

1000

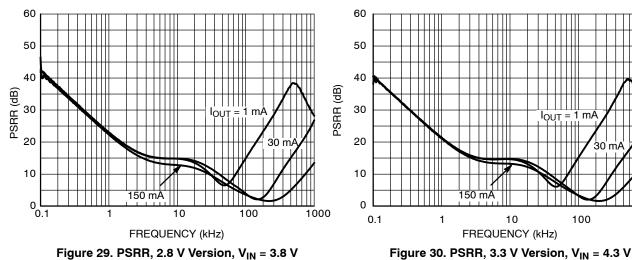


Figure 29. PSRR, 2.8 V Version,  $V_{IN}$  = 3.8 V

3.0

2.5

 $(^{2.0}_{N})^{N}$  ( $^{1.5}_{N}$ ) 1.0

0.5

0.01

0.1

2.5 2.0  $V_N (\mu V_{rms} / \sqrt{Hz})$ 1.5 1.0 0.5 0 0.01 1000 0.1 1 10 100 1000 FREQUENCY (kHz)

FREQUENCY (kHz) Figure 31. Output Voltage Noise, 1.2 V Version, V<sub>IN</sub> = 2.2 V, I<sub>OUT</sub> =30 mA

10

100

Figure 32. Output Voltage Noise, 2.5 V Version, V<sub>IN</sub> = 3.5 V, I<sub>OUT</sub> =30 mA

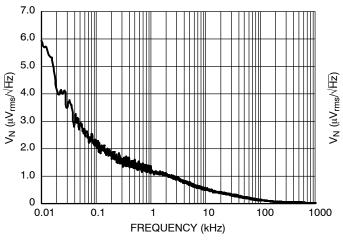


Figure 33. Output Voltage Noise, 2.8 V Version,  $V_{\text{IN}}$  = 3.8 V,  $I_{\text{OUT}}$  =30 mA

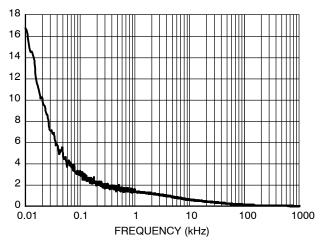


Figure 34. Output Voltage Noise, 3.3 V Version,  $V_{IN}$  = 4.3 V,  $I_{OUT}$  =30 mA

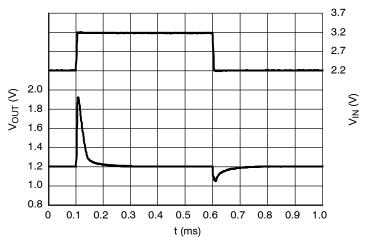


Figure 35. Line Transients, 1.2 V Version,  $t_R$  =  $t_F$  = 5  $\mu$ s,  $l_{OUT}$  = 30 mA

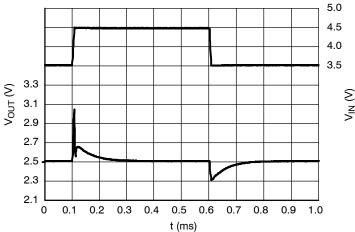


Figure 36. Line Transients, 2.5 V Version,  $t_R = t_F = 5 \mu s$ ,  $l_{OUT} = 30 \text{ mA}$ 

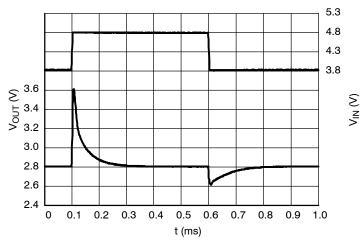


Figure 37. Line Transients, 2.8 V Version,  $t_R = t_F = 5~\mu s, \, l_{OUT} = 30~mA$ 

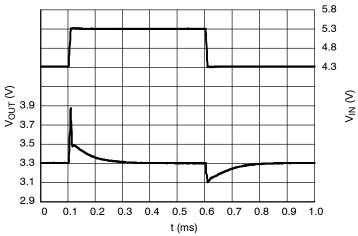


Figure 38. Line Transients, 3.3 V Version,  $t_R = t_F = 5~\mu s, ~l_{OUT} = 30~mA$ 

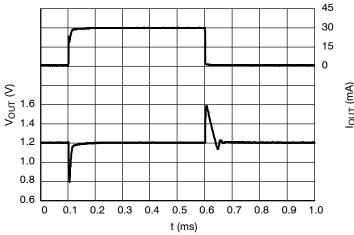


Figure 39. Load Transients, 1.2 V Version,  $I_{OUT}$  = 1 - 30 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 2.2 V

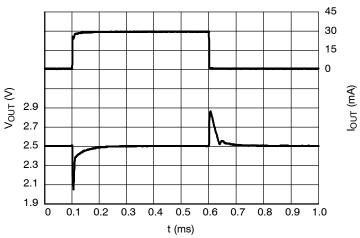
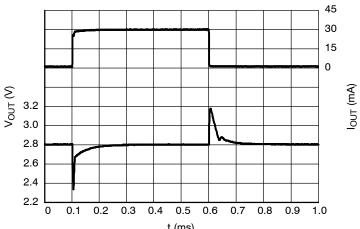


Figure 40. Load Transients, 2.5 V Version,  $I_{OUT}$  = 1 - 30 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 3.5 V



 $$^{\rm t}$  (ms) Figure 41. Load Transients, 2.8 V Version,  $I_{OUT}$  = 1 - 30 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 3.8 V

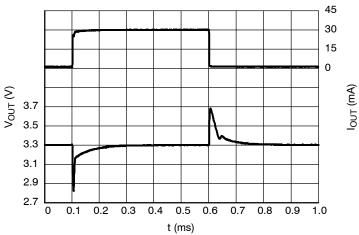


Figure 42. Load Transients, 3.3 V Version,  $I_{OUT}$  = 1 - 30 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 4.3 V

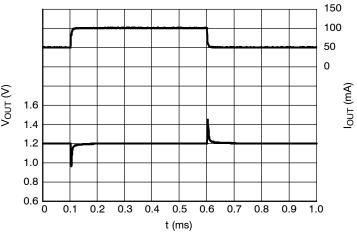


Figure 43. Load Transients, 1.2 V Version,  $I_{OUT}$  = 50 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 2.2 V

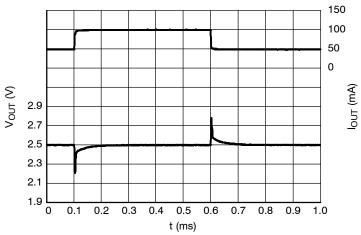


Figure 44. Load Transients, 2.5 V Version,  $I_{OUT}$  = 50 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 3.5 V

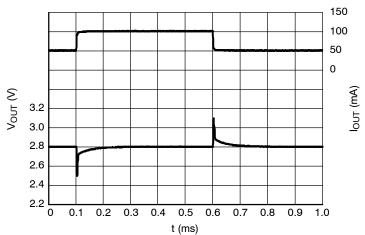


Figure 45. Load Transients, 2.8 V Version,  $I_{OUT}$  = 50 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 3.8 V

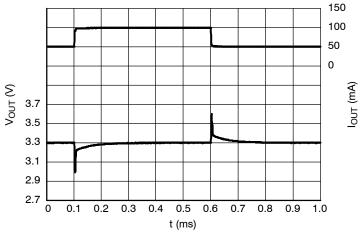


Figure 46. Load Transients, 3.3 V Version,  $I_{OUT}$  = 50 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s,\,V_{IN}$  = 4.3 V

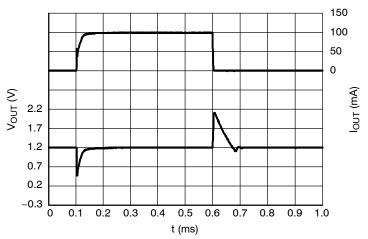


Figure 47. Load transients, 1.2 V Version,  $I_{OUT}$  = 1 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 2.2 V

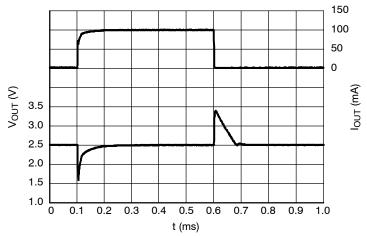


Figure 48. Load Transients, 2.5 V Version,  $I_{OUT}$  = 1 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 3.5 V

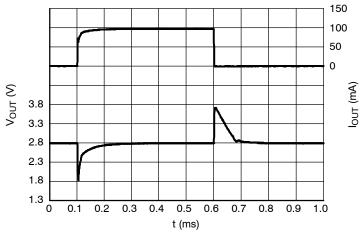


Figure 49. Load Transients, 2.8 V Version,  $I_{OUT}$  = 1 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 3.8 V

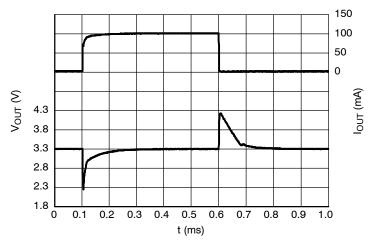


Figure 50. Load Transients, 3.3 V Version,  $I_{OUT}$  = 1 - 100 mA,  $t_R$  =  $t_F$  = 0.5  $\mu s, \, V_{IN}$  = 4.3 V

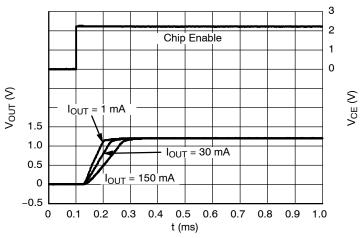


Figure 51. Start-up, NCP4682 1.2 V Version,  $V_{IN}$  = 2.2 V

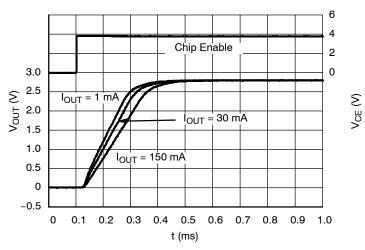


Figure 52. Start-up, NCP4682 2.8 V Version,  $V_{\text{IN}}$  = 3.8 V

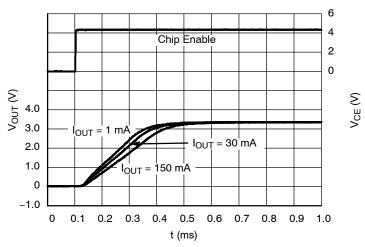


Figure 53. Start-up, NCP4682 3.3 V Version,  $V_{\text{IN}} = 4.3 \text{ V}$ 

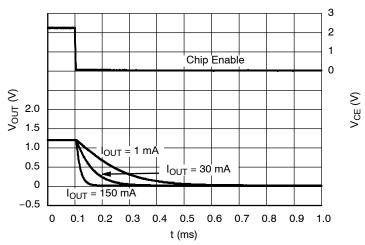


Figure 54. Shutdown, NCP4682 1.2 V Version D,  $V_{IN}$  = 2.2 V

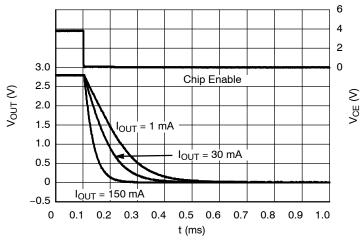


Figure 55. Shutdown, NCP4682 2.8 V Version D,  $$V_{\mbox{\footnotesize{IN}}}$= 3.8 \mbox{ V}$ 

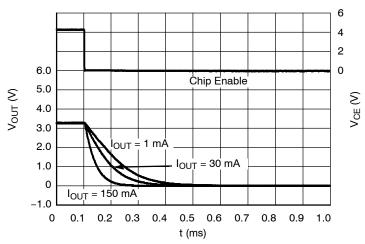


Figure 56. Shutdown, NCP4682 3.3 V Version D,  $V_{IN}$  = 4.3 V

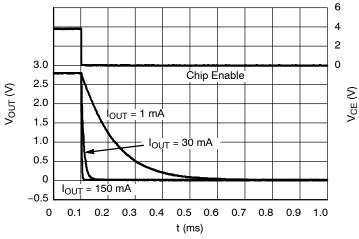


Figure 57. Shutdown, NCP4682 2.8 V Version H,  $$V_{\mbox{\scriptsize IN}}$= 3.8 \mbox{ V}$ 

#### APPLICATION INFORMATION

A typical application circuits for NCP4682 and NCP4685 series is shown in Figure 58.

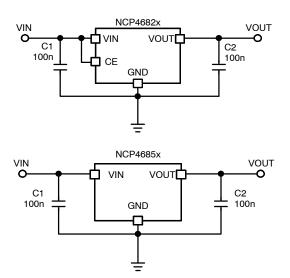


Figure 58. Typical Application Schematic

# Input Decoupling Capacitor (C1)

A  $0.1~\mu F$  ceramic input decoupling capacitor should be connected as close as possible to the input and ground pin of the NCP4682/5. Higher values and lower ESR improves line transient response.

#### **Output Decoupling Capacitor (C2)**

A 0.1  $\mu F$  ceramic output decoupling capacitor is enough to achieve stable operation of the IC. If a tantalum capacitor is used, and its ESR is high, loop oscillation may result. The capacitors should be connected as close as possible to the output and ground pins. Larger values and lower ESR improves dynamic parameters.

### **Current Limit**

This regulator includes a fold-back current limiting circuit. This type of protection doesn't limit output current

up to specified current capability in normal operation, but when an over current situation occurs, the output voltage and current decrease until the over current condition ends. Typical characteristics of this protection scheme are shown in the Output voltage versus Output current graphs in the characterization section of this datasheet.

### **Enable Operation (NCP4682 Only)**

The enable pin CE may be used for turning the regulator on and off. The IC is switched on when a high level voltage is applied to the CE pin. The enable pin has an internal pull down current source. If the enable function is not needed, connect CE pin to VIN.

#### Output Discharger (NCP4682 Only)

The NCP4682D version includes a transistor between VOUT and GND that is used for faster discharging of the output capacitor. This function is activated when the IC goes into disable mode.

#### **Thermals**

As a power across the IC increase, it might become necessary to provide some thermal relief. The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and also the ambient temperature affect the rate of temperature increase for the part. When the device has good thermal conductivity through the PCB the junction temperature will be relatively low in high power dissipation applications.

#### **PCB** layout

Make the VIN and GND line as large as practical. If their impedance is high, noise pickup or unstable operation may result. Connect capacitors C1 and C2 as close as possible to the IC, and make wiring as short as possible.

# **ORDERING INFORMATION**

Device	Nominal Output Voltage	Description	Marking	Package	Shipping
NCP4682DMU12TCG	1.2 V	Auto discharge	CA		
NCP4682DMU15TCG	1.5 V	Auto discharge	CC		
NCP4682DMU18TCG	1.8 V	Auto discharge	CD		
NCP4682DMU19TCG	1.9 V	Auto discharge	CF		
NCP4682DMU25TCG	2.5 V	Auto discharge	CH		
NCP4682DMU28TCG	2.8 V	Auto discharge	CL	UDFN4	40000 (Tree 0 Deel
NCP4682DMU30TCG	3.0 V	Auto discharge	CP	(Pb-Free)	10000 / Tape & Reel
NCP4682DMU33TCG	3.3 V	Auto discharge	CR		
NCP4682HMU18TCG	1.8 V	Enable high	AD		
NCP4682HMU28TCG	2.8 V	Enable high	AL		
NCP4682HMU33TCG	3.3 V	Enable high	AR		
NCP4685EMU30TCG	3.0 V	Without enable	BP		
NCP4682DSN30T1G	3.0 V	Auto discharge	92P	SOT-23-5	0000 / Table 0 Deed
NCP4682DSN33T1G	3.3 V	Auto discharge	92R	(Pb-Free)	3000 / Tape & Reel
NCP4682DSQ12T1G	1.2 V	Auto discharge	R0		
NCP4682DSQ15T1G	1.5 V	Auto discharge	R2	-	
NCP4682DSQ18T1G	1.8 V	Auto discharge	R3		
NCP4682DSQ20T1G	2.0 V	Auto discharge	R6		
NCP4682DSQ25T1G	2.5 V	Auto discharge	R7	SC-82AB	0000 / T
NCP4682DSQ28T1G	2.8 V	Auto discharge	S0	(Pb-Free)	3000 / Tape & Reel
NCP4682DSQ33T1G	3.3 V	Auto discharge	S5	1	
NCP4685ESQ15T1G	1.5 V	Without enable	N2	1	
NCP4685ESQ25T1G	2.5 V	Without enable	N7	1	
NCP4685ESQ33T1G	3.3 V	Without enable	P5	1	

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
\*To order other package and voltage variants, please contact your ON Semiconductor sales representative.

# **MECHANICAL CASE OUTLINE**

**PACKAGE DIMENSIONS** 



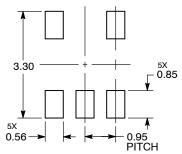


SOT-23 5-LEAD CASE 1212-01 **ISSUE A** 

**DATE 28 JAN 2011** 

# Α В 0.05 S 5X **b** L1 ⊕ 0.10 M C B S A S

#### RECOMMENDED **SOLDERING FOOTPRINT\***



DIMENSIONS: MILLIMETERS

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER
  ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSIONS: MILLIMETERS.
  3. DATUM C IS THE SEATING PLANE.

	MILLIMETERS		
DIM	MIN MAX		
Α		1.45	
A1	0.00	0.10	
A2	1.00	1.30	
b	0.30	0.50	
C	0.10	0.25	
D	2.70	3.10	
E	2.50	3.10	
E1	1.50	1.80	
е	0.95 BSC		
L	0.20		
L1	0.45	0.75	

### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	SOT-23 5-LEAD		PAGE 1 OF 1

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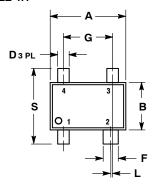
<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

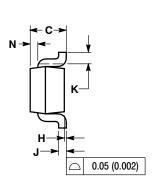


SC-82AB CASE 419C-02 ISSUE F

**DATE 22 JUN 2012** 

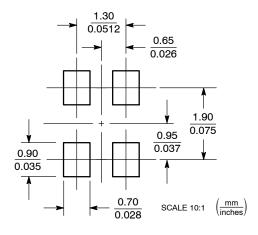
#### SCALE 4:1







#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. 419C-01 OBSOLETE. NEW STANDARD IS 419C-02.

  4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE RI IRRS.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	1.80	2.20	0.071	0.087
В	1.15	1.35	0.045	0.053
С	0.80	1.10	0.031	0.043
D	0.20	0.40	0.008	0.016
F	0.30	0.50	0.012	0.020
G	1.10	1.50	0.043	0.059
Н	0.00	0.10	0.000	0.004
J	0.10	0.26	0.004	0.010
K	0.10		0.004	
L	0.05 BSC		0.002	BSC
N	0.20	REF	0.008	REF
S	1.80	2.40	0.07	0.09

# **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Month Code Μ

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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DESCRIPTION:	SC-82AB		PAGE 1 OF 1

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# **MECHANICAL CASE OUTLINE**



### UDFN4 1.0x1.0, 0.65P CASE 517BR-01 **ISSUE O**

**DATE 27 OCT 2010** 

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
- DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND
- 0.20 mm FROM TERMINAL.

4.	COPLANARITY APPLIES TO THE EXPOSED
	PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α		0.60	
A1	0.00	0.05	
А3	0.10 REF		
b	0.20	0.30	
D	1.00 BSC		
D2	0.43	0.53	
E	1.00 BSC		
е	0.65 BSC		
L	0.20	0.30	
L2	0.27	0.37	
L3	0.02	0.12	

#### **GENERIC MARKING DIAGRAM\***



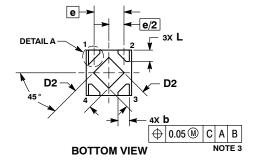
XX = Specific Device Code

MM = Date Code

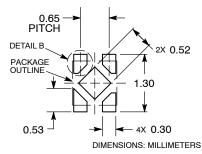
\*This information is generic. Please refer to device data sheet for actual part marking.

Pb-Free indicator, "G" or microdot " ■", may or may not be present.

#### 4X L3 В c 0.18 PIN ONE REFERENCE **DETAIL A** 0.05 2X 🗀 0.05 С 3X 0.43 4X 0.23 TOP VIEW (A3)0.05 C **≪** 3X 0 10 0.05 C **DETAIL B** C SEATING PLANE NOTE 4 SIDE VIEW



#### **RECOMMENDED MOUNTING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	UDFN4, 1.0X1.0, 0.65P		PAGE 1 OF 1

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